NICHIA CORPORATION

SPECIFICATIONS FOR WHITE LED

PART NO. NSSWT02AT-V2

• Pb-free Reflow Soldering Application

• RoHS Compliant





SPECIFICATIONS

(1) Absolute Maximum Ratings

| Item | Symbol | Absolute Maximum Rating | Unit |
|-----------------------|-------------------|-------------------------|------|
| Forward Current | \mathbf{I}_{F} | 130 | mA |
| Pulse Forward Current | \mathbf{I}_{FP} | 150 | mA |
| Reverse Voltage | V _R | 5 | V |
| Power Dissipation | PD | 416 | mW |
| Operating Temperature | T _{opr} | -40~100 | °C |
| Storage Temperature | T _{stg} | -40~100 | °C |
| Junction Temperature | Tı | 120 | °C |

* Absolute Maximum Ratings at $T_s=25$ °C.

* I_{FP} conditions with pulse width ${\leq}10\text{ms}$ and duty cycle ${\leq}10\%.$

(2) Initial Electrical/Optical Characteristics

| Ite | Symbol | Condition | Тур | Max | Unit | |
|-------------------------|-----------------------|----------------|----------------------|-------|------|------|
| Forward Voltage | | VF | I⊧=65mA | 2.94 | - | V |
| Reverse Current | | I _R | $V_R = 5V$ | - | - | μA |
| DDDDD | Luminous Flux | Φv | I₅=65mA | 30.5 | - | lm |
| R8000 | Color Rendering Index | Ra | I₅=65mA | 83 | - | - |
| | Luminous Flux | Φv | I _F =65mA | 25.9 | - | lm |
| R90 | Color Rendering Index | Ra | I₅=65mA | 93 | - | - |
| | x | | I₅=65mA | 0.349 | - | |
| Chromaticity Coordinate | у | - | I _F =65mA | 0.361 | - | - |
| Thermal Resistance | | Rejs | - | 40 | 65 | °C/W |

* Characteristics at $T_s=25$ °C.

* Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

* $R_{\mbox{\tiny BJS}}$ is the thermal resistance from the junction to the T_S measurement point.

^{*} Luminous Flux value as per CIE 127:2007 standard.

RANKS

| Item | Rank | | Min | Max | Unit |
|-----------------------|-------|----------------|------|------|------|
| Forward Voltage | - | | 2.75 | 3.20 | V |
| Reverse Current | - | | - | 50 | μA |
| | P11 | | 30.3 | 36.0 | |
| Luminous Flux | P10 | | 25.5 | 30.3 | |
| | Р9 | | 21.4 | 25.5 | lm |
| | P8 | | 18.0 | 21.4 | |
| | | Ra | 80 | - | |
| Color Rendering Index | R8000 | R ₉ | >0 | - | - |
| | R90 | Ra | 90 | - | |

Color Ranks

The color ranks have chromaticity ranges within 3-step MacAdam ellipse.

| | | Rank | Rank | Rank |
|------------------------|---|----------|----------|----------|
| | | sm5031n | sm5731n | sm6531n |
| | х | 0.349 | 0.333 | 0.316 |
| Center Point | у | 0.361 | 0.348 | 0.334 |
| Minor Axis | а | 0.003693 | 0.003279 | 0.002829 |
| Major Axis | b | 0.008619 | 0.007854 | 0.006822 |
| Ellipse Rotation Angle | Φ | -32.21 | -30.83 | -32.38 |

The color ranks have chromaticity ranges within 5-step MacAdam ellipse.

| | | Rank | Rank | Rank | Rank | Rank | Rank |
|------------------------|----------|----------|----------|----------|----------|----------|------|
| | sm5051na | sm5051nb | sm5051nc | sm5051nd | sm5051ne | sm5051nf | |
| | х | 0.349 | | | | | |
| Center Point | у | 0.361 | | | | | |
| Minor Axis | а | 0.006155 | | | | | |
| Major Axis | b | 0.014365 | | | | | |
| Ellipse Rotation Angle | Φ | | | -32 | 2.21 | | |

| | | Rank | Rank | Rank | Rank | Rank | Rank |
|------------------------|----------|----------|----------|----------|----------|----------|------|
| | sm5751na | sm5751nb | sm5751nc | sm5751nd | sm5751ne | sm5751nf | |
| | х | 0.333 | | | | | |
| Center Point | у | 0.348 | | | | | |
| Minor Axis | а | 0.005465 | | | | | |
| Major Axis | b | 0.013090 | | | | | |
| Ellipse Rotation Angle | Φ | -30.83 | | | | | |

| | | Rank | Rank | Rank | Rank | Rank | Rank |
|------------------------|---|----------|----------|----------|----------|----------|----------|
| | | sm6551na | sm6551nb | sm6551nc | sm6551nd | sm6551ne | sm6551nf |
| | х | 0.316 | | | | | |
| Center Point | у | 0.334 | | | | | |
| Minor Axis | а | 0.004715 | | | | | |
| Major Axis | b | 0.011370 | | | | | |
| Ellipse Rotation Angle | Φ | | | -32 | .38 | | |

* Ranking at Ts=25°C.

* Forward Voltage Tolerance: ±0.05V

* Luminous Flux Tolerance: ±7%

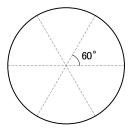
* Color Rendering Index R_a Tolerance: ±2

* Color Rendering Index R₉ Tolerance: ±6.5

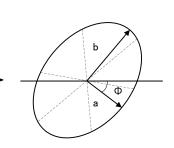
* Chromaticity Coordinate Tolerance: ±0.005

* LEDs from the above ranks will be shipped. The rank combination ratio per shipment will be decided by Nichia.

Definition of the MacAdam ellipse ranks:



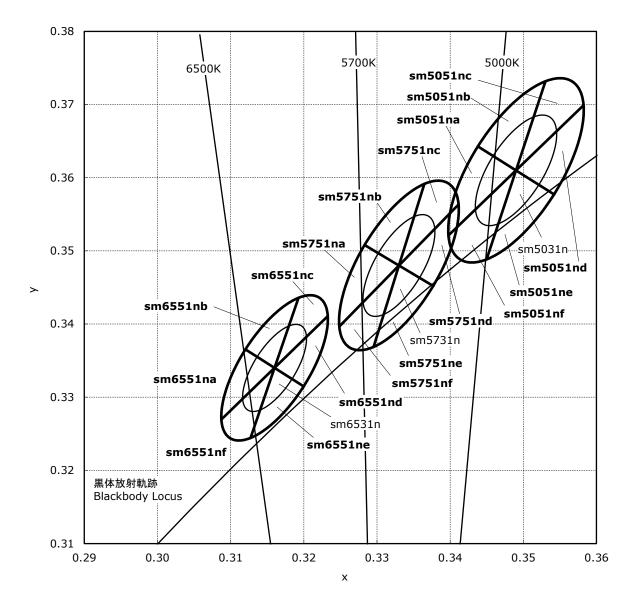
A perfect circle is divided into 60 degree-sections and then transformed into the MacAdam ellipse that is presented on the chromaticity diagram in this document.



Luminous Flux Ranks by Color Rank, Color Rendering Index Rank

| L Ranking by Color Coordinates, Color Rendering Index | Ranking by uminous Flux | P8 | P9 | P10 | P11 |
|---|----------------------------|----|----|-----|-----|
| | R8000 | | | | |
| sm5031n,sm5051na,sm5051nb,sm5051nc,sm5051nd,sm5051ne,sm5051nf | R90 | | | | |
| sm5731n,sm5751na,sm5751nb,sm5751nc,sm5751nd,sm5751ne,sm5751nf, sm6531n,sm6551na,sm6551nb,sm6551nc,sm6551nd,sm6551ne,sm6551nf | R8000 | | | | |

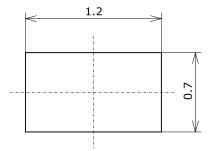
CHROMATICITY DIAGRAM

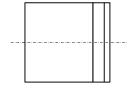


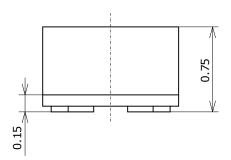
OUTLINE DIMENSIONS

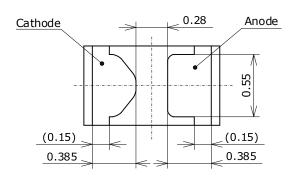
* 括弧で囲まれた寸法は参考値です。 The dimension(s) in parentheses are for reference purposes. NSSxT02A-Vx 管理番号 No. STS-DA7-6627C

(単位 Unit: mm, 公差 Tolerance: ±0.1)







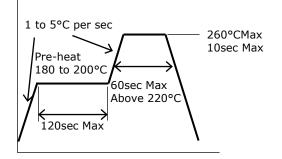


| 項目 Item | 内容 Description |
|--|--|
| パッケージ材質 Package Materials | ガラスエポキシ基板 Glass Fabric Based-epoxy Resin |
| 封止樹脂材質 Encapsulating Resin Materials | シリコーン樹脂 (拡散剤+蛍光体入り) Silicone Resin (with diffuser and phosphor) |
| 電極材質 Electrodes Materials | 金メッキ Au-plated |
| 質量 Weight | 0.0013g(TYP) |

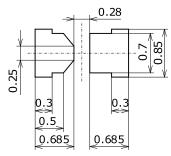


SOLDERING

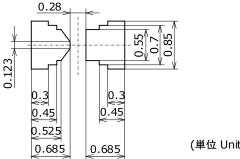
Recommended Reflow Soldering Condition(Lead-free Solder)



Recommended Soldering Pad Pattern







(単位 Unit: mm)

- * This LED is designed to be reflow soldered to a PCB. If dip soldered or hand soldered, Nichia will not guarantee its reliability.
- * Reflow soldering must not be performed more than twice.
- * When cooling the LEDs from the peak temperature a gradual cooling slope is recommended; do not cool the LEDs rapidly.
- * During reflow soldering, the heat and atmosphere in the reflow oven may cause the optical characteristics to degrade. In particular, reflow soldering performed with an air atmosphere may have a greater negative effect on the optical characteristics than if a nitrogen atmosphere is used; Nichia recommends using a nitrogen reflow atmosphere.
- * Since the silicone used in the encapsulating resin is soft, do not press on the encapsulant resin. Pressure can cause nicks, chip-outs, encapsulant delamination and deformation, and bump breaks, decreasing reliability.

When using automatic pick and place machine, use a pick up nozzle which does not directly apply excess stress to the encapsulation of the LEDs.

Recommended conditions:

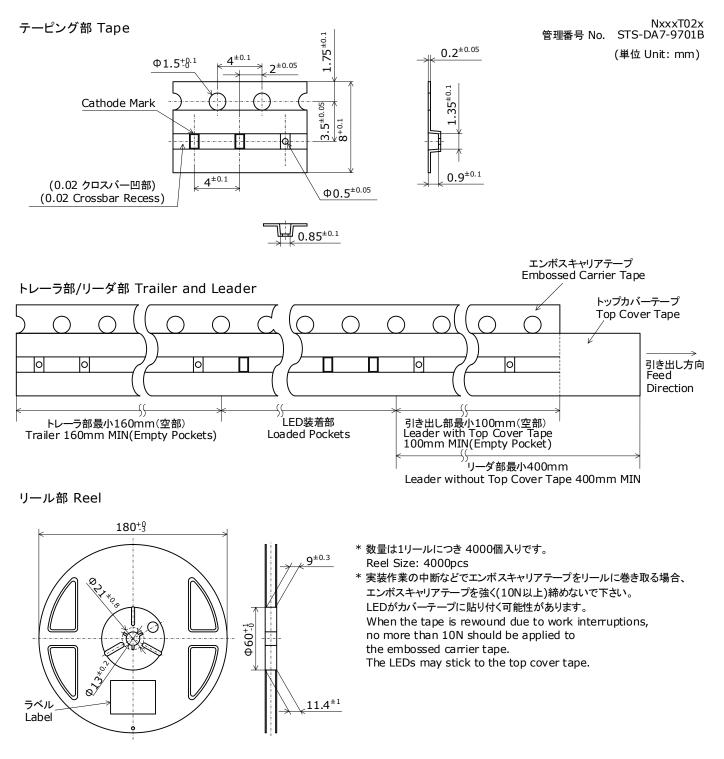
Nozzle Panasonic: #10807GH811AG

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JUKI:#502
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(Picking on the upper surface possible)

- * Once the LEDs have been soldered to a PCB, it should not be repaired/reworked. If it must be done, using a hot plate is strongly recommended. Sufficient verification should be performed prior to use to ensure that the repair/rework does not cause the LED characteristics to deteriorate.
- * When soldering, do not apply stress to the LED while the LED is hot.
- * When using an automatic pick-and-place machine, choose an appropriate nozzle for this LED. Using a pick-and-place nozzle with a smaller diameter than the size of the LED's emitting surface will cause damage to the emitting surface causing a catastrophic failure (i.e. the LED not to illuminate).
- * The soldering pad pattern above is a general recommendation for LEDs to be mounted without issues; if a high degree of precision is required for the chosen application (i.e. high-density mounting), ensure that the soldering pad pattern is optimized.
- * When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
- * Ensure that there are no issues with the type and amount of solder that is being used.
- * This LED has all the electrodes on the backside; solder connections will not be able to be seen nor confirmed by a normal visual inspection. Ensure that sufficient verification is performed on the soldering conditions prior to use to ensure that there are no issues.

TAPE AND REEL DIMENSIONS



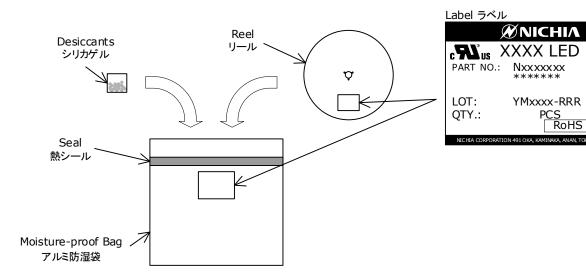
PACKAGING - TAPE & REEL

Moisture-proof bags are packed in cardboard boxes with corrugated partitions. アルミ防湿袋を並べて入れ、ダンボールで仕切ります。

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Nichia LED

Reels are shipped with desiccants in heat-sealed moisture-proof bags. シリカゲルとともにリールをアルミ防湿袋に入れ、熱シールにより封をします。 Part No. Nxxxxxx No. STS-DA7-4989C



Label NICHIA NICHIA NICHIA CNUS XXXX LED PART NO.: NXXXXXX ******* RANK: RRR QTY.: PCS RoHS

- ******* is the customer part number. If not provided, it will not be indicated on the label. 客先型名を******で示します。 客先型名が設定されていない場合は空白です。
- For details, see "LOT NUMBERING CODE" in this document.
 ロット表記方法についてはロット番号の項を 参照して下さい。

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- The label does not have the RANK field for un-ranked products.
 ランク分けがない場合はランク表記はありません。
- * Products shipped on tape and reel are packed in a moisture-proof bag. They are shipped in cardboard boxes to protect them from external forces during transportation. 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
- * Do not drop or expose the box to external forces as it may damage the products. 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。
- * Do not expose to water. The box is not water-resistant. ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。
- * Using the original package material or equivalent in transit is recommended. 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。

LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

| Y - Year |
|----------|
|----------|

| Year | Y |
|------|---|
| 2021 | L |
| 2022 | М |
| 2023 | Ν |
| 2024 | 0 |
| 2025 | Р |
| 2026 | Q |

M - Month

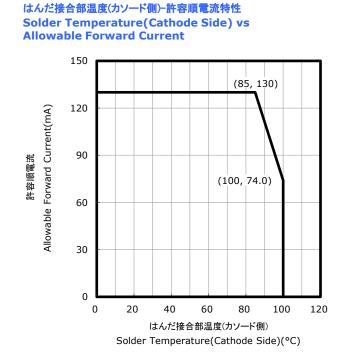
| Month | М | Month | М |
|-------|---|-------|---|
| 1 | 1 | 7 | 7 |
| 2 | 2 | 8 | 8 |
| 3 | 3 | 9 | 9 |
| 4 | 4 | 10 | А |
| 5 | 5 | 11 | В |
| 6 | 6 | 12 | С |

xxxx-Nichia's Product Number

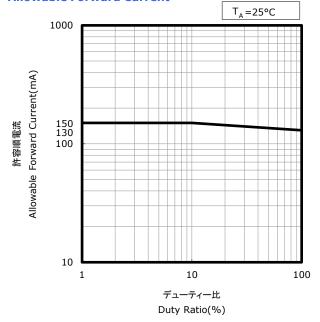
RRR-Ranking by Color Coordinates, Ranking by Luminous Flux, Ranking by Color Rendering Index

DERATING CHARACTERISTICS

NSSxT02A-Vx 管理番号 No. STS-DA7-6628C





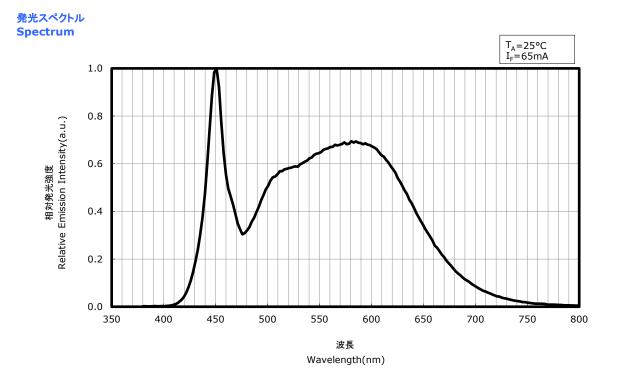


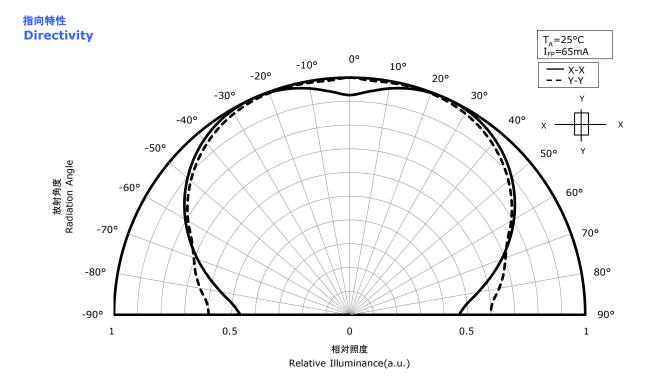
10

OPTICAL CHARACTERISTICS



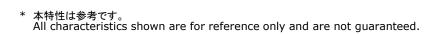
NSSWT02A-V2 管理番号 No. STS-DA7-9687



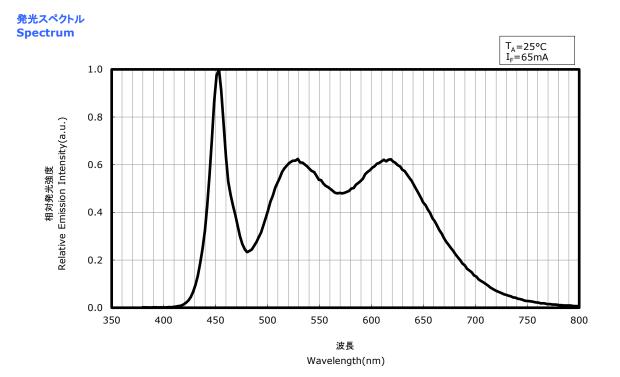


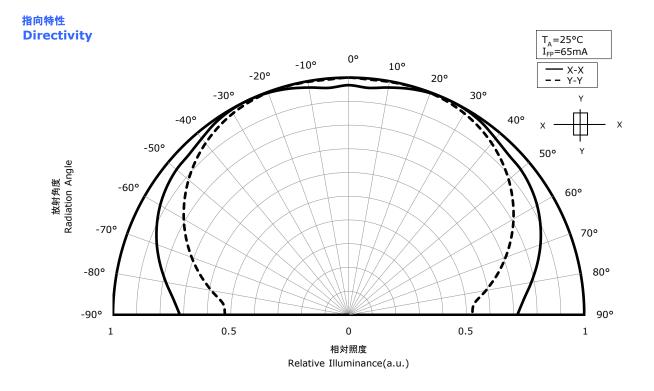
*本特性は演色性ランクR8000に対応しています。 The graphs above show the characteristics for R8000 LEDs of this product.

OPTICAL CHARACTERISTICS



NSSWT02A-V2 管理番号 No. STS-DA7-9688



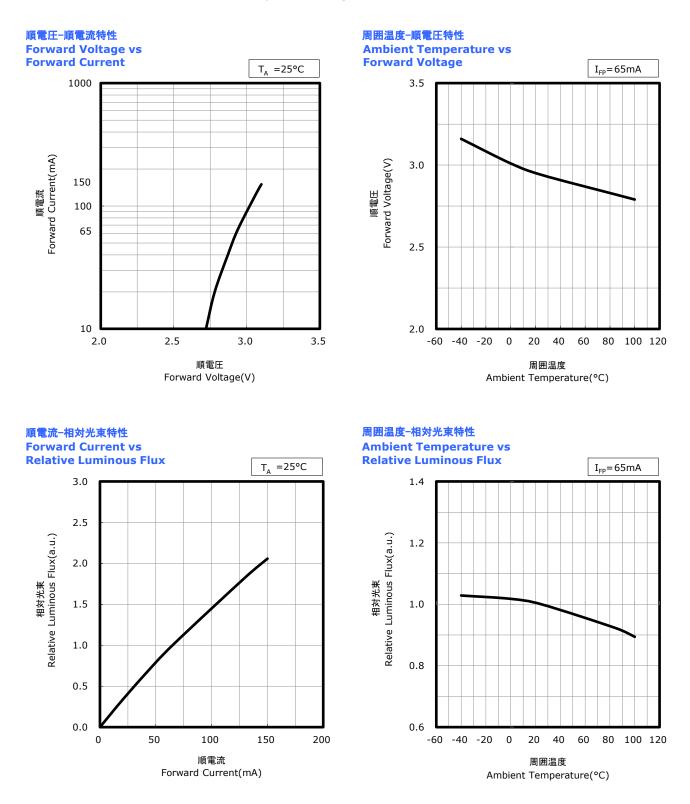


* 本特性は演色性ランクR90に対応しています。 The graphs above show the characteristics for R90 LEDs of this product.

* 本特性は参考です。

All characteristics shown are for reference only and are not guaranteed.

NSSWT02A-V2 管理番号 No. STS-DA7-9689

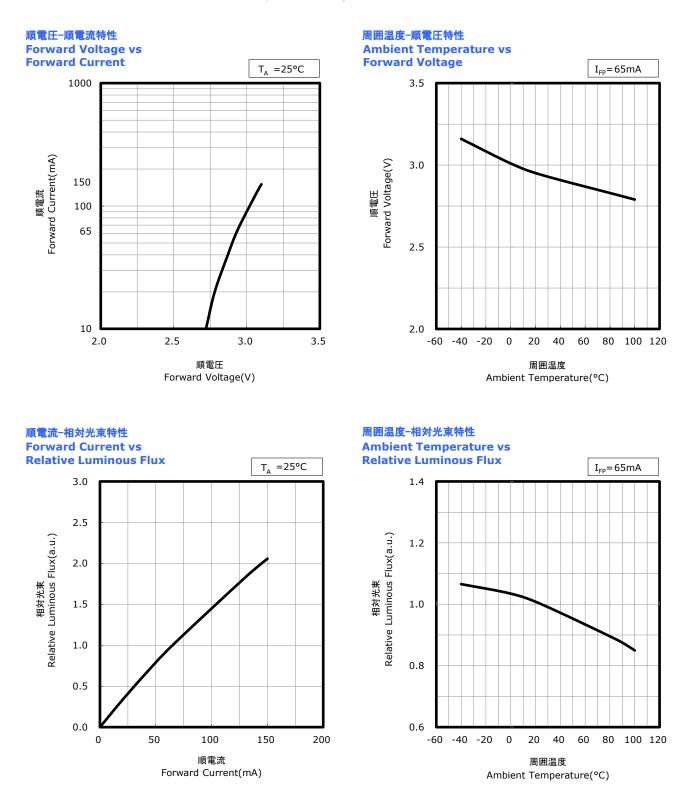


*本特性は演色性ランクR8000に対応しています。 The graphs above show the characteristics for R8000 LEDs of this product.

* 本特性は参考です。

All characteristics shown are for reference only and are not guaranteed.

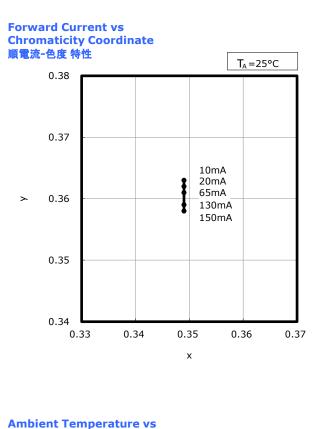
NSSWT02A-V2 管理番号 No. STS-DA7-9690

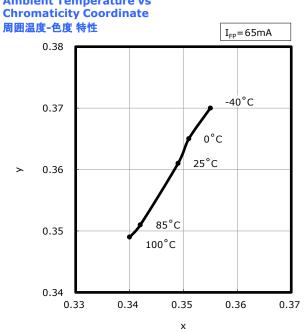


* 本特性は演色性ランクR90に対応しています。 The graphs above show the characteristics for R90 LEDs of this product.

* All characteristics shown are for reference only and are not guaranteed. 本特性は参考です。

Part No. NSSWT02A-V2 No. STS-DA7-9691A

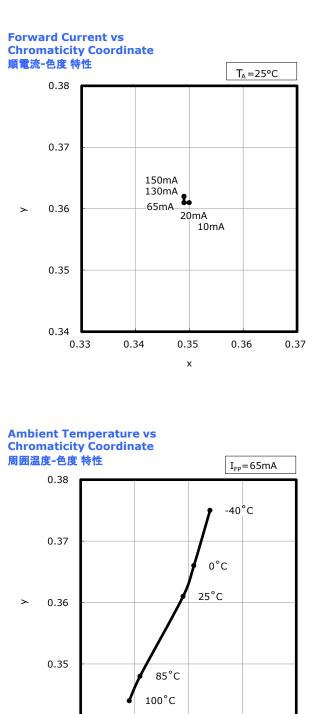




* The graphs above show the characteristics for R8000 LEDs of this product. 本特性は演色性ランクR8000に対応しています。

* All characteristics shown are for reference only and are not guaranteed. 本特性は参考です。

Part No. NSSWT02A-V2 No. STS-DA7-9692A



* The graphs above show the characteristics for R90 LEDs of this product. 本特性は演色性ランクR90に対応しています。

0.34

0.34

0.35

х

0.36

0.37

RELIABILITY

(1) Tests and Results

| Test | Reference Standard | Test Conditions | Test Duration | Failure Criteria # | Units Failed/Tested |
|---|---------------------------|---|------------------|--------------------------|------------------------|
| Resistance to Soldering Heat (Reflow Soldering) | JEITA ED-4701 300 301 | T _{sld} =260°C, 10sec, 2reflows, Precondition: 30°C, 70%RH, 4weeks | | #1 | 0/22 |
| Solderability | JEITA ED-4701 303 303A | T _{sld} =245±5°C, 5sec, Lead-free Solder(Sn-3.0Ag-0.5Cu) | | #2 | 0/22 |
| Temperature Cycle | JEITA ED-4701 100 105 | -40°C(30min)~25°C(5min)~ 100°C(30min)~25°C(5min) | 100cycles | #1 | 0/50 |
| Moisture Resistance (Cyclic) | JEITA ED-4701 200 203 | 25°C~65°C~-10°C, 90%RH, 24hr per cycle | 10cycles | #1 | 0/22 |
| High Temperature Storage | JEITA ED-4701 200 201 | T _A =100°C | 1000hours | #1 | 0/22 |
| Temperature Humidity Storage | JEITA ED-4701 100 103 | T _A =60°C, RH=90% | 1000hours | #1 | 0/22 |
| Low Temperature Storage | JEITA ED-4701 200 202 | T _A =-40°C | 1000hours | #1 | 0/22 |
| Room Temperature Operating Life Condition 1 | | T₄=25°C, I⊧=65mA Test board: See NOTES below | 1000hours | #1 | 0/22 |
| Room Temperature Operating Life Condition 2 | | T _A =25°C, I _F =130mA Test board: See NOTES below | 500hours | #1 | 0/22 |
| High Temperature Operating Life | | T _A =100°C, I _F =50mA Test board: See NOTES below | 1000hours | #1 | 0/22 |
| Temperature Humidity Operating Life | | 60°C, RH=90%, I _F =65mA Test board: See NOTES below | 500hours | #1 | 0/22 |
| Low Temperature Operating Life | | T₄=-40°C, I⊧=65mA Test board: See NOTES below | 1000hours | #1 | 0/22 |
| Vibration | JEITA ED-4701 400 403 | , | | #1 | 0/22 |
| Soldering Joint Shear Strength | JEITA ED-4702B 002 3 | 5N, 10±1sec | | #1 | 0/22 |

NOTES:

Measurements are performed after allowing the LEDs to return to room temperature.

(2) Failure Criteria

| | Criteria # | Items | Conditions | Failure Criteria | |
|----|------------------|----------------------------------|----------------------|-----------------------------------|--|
| | | Forward Voltage(V _F) | I _F =65mA | >U.S.L.×1.1 | |
| #1 | | Luminous Flux(Φ_v) | I₅=65mA | <l.s.l.×0.7< td=""></l.s.l.×0.7<> | |
| | | Reverse Current(I _R) | V _R =5V | >U.S.L.×2.0 | |
| | #2 Solderability | | - | Less than 95% solder coverage | |

U.S.L. : Upper Specification Limit L.S.L. : Lower Specification Limit

CAUTIONS

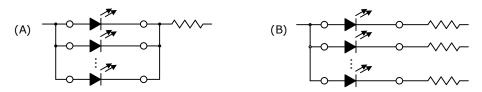
(1) Storage

| Conditions | | Temperature | Humidity | Time |
|------------|-----------------------------|-------------|----------|----------------------------------|
| | Before Opening Aluminum Bag | ≤30°C | ≤90%RH | Within 1 Year from Delivery Date |
| Storage | After Opening Aluminum Bag | ≤30°C | ≤70%RH | ≤4weeks |

- The storage/packaging requirements for this LED are comparable to JEDEC Moisture Sensitivity Level (MSL) 2a or equivalent. Nichia used IPC/JEDEC STD-020 as a reference to rate the MSL of this LED.
- Ensure that soldering is completed within the storage times detailed above.
- This LED uses a package that could absorb moisture; if the package absorbs moisture and is exposed to heat during soldering, it may cause the moisture to vaporize and the package to expand and the resulting pressure may cause internal delamination. This may cause the optical characteristics to degrade. To minimize moisture absorption in storage/transit, moisture-proof aluminum bags are used for the LEDs with a silica gel packet to absorb any air moisture in the bag. The silica gel beads turn blue to red as they absorb moisture.
- Once the moisture-proof aluminum bag is open, ensure that the LED is soldered to a PCB within the range of the conditions above. To store any remaining unused LEDs, use a hermetically sealed container with silica gel desiccants. Nichia recommends placing them back to the original moisture-proof bag and reseal it.
- This LED has gold-plated electrodes. If the LEDs are exposed to a corrosive environment, it may cause the plated surface to tarnish causing issues (i.e. solderability). Ensure that when storing LEDs, a hermetically sealed container is used. Nichia recommends placing them back to the original moisture-proof bag and reseal it.
- To prevent substances/gases from affecting the plated surface, ensure that the parts/materials used with the LEDs in the same assembly/system do not contain sulfur (e.g. gasket/seal, adhesive, etc.). If the plating is contaminated, it may cause issues (e.g. electric connection failures). If a gasket/seal is used, silicone rubber gaskets/seals are recommended; ensure that this use of silicone does not result in issues (e.g. electrical connection failures) caused by low molecular weight volatile siloxane.
- To avoid condensation, the LEDs must not be stored in areas where temperature and humidity fluctuate greatly.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment over a long period of time where the temperature is higher than normal room temperature.

(2) Directions for Use

• The circuit must be designed to ensure that the Absolute Maximum Ratings are not exceeded for each LED. The LEDs should be operated at a constant current per LED. In the case of operating at a constant voltage, Circuit B is recommended. If Circuit A is used, it may cause the currents flowing through the LEDs to vary due to the variation in the forward voltage characteristics of the LEDs on the circuit.



- This LED is designed to be operated at a forward current. Ensure that no voltage is applied to the LED in the forward/reverse direction while the LED is off. If the LEDs are used in an environment where reverse voltages are applied to the LED continuously, it may cause electrochemical migration to occur causing the LED to be damaged. When not in use for a long period of time, the system's power should be turned off to ensure that there are no issues/damage.
- To stabilize the LED characteristics while in use, Nichia recommends that the LEDs are operated at currents ≥ 10% of the sorting current.
- If LEDs are arranged into rows and columns in a grid circuit (i.e. LED matrix circuit) and operated, ensure that when using a pulsed mode to operate the LEDs in a matrix circuit, the reverse voltage for any of the LEDs does not exceed the Absolute Maximum Rating while the LED is off.
- Ensure that transient excessive voltages (e.g. lightning surge) are not applied to the LEDs.
- If the LEDs are used for outdoor applications, ensure that necessary measures are taken (e.g. protecting the LEDs from water/salt damage and high humidity).

(3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the bump to break, which will cause the LED not to illuminate.
- Ensure that when handling the LEDs with tweezers, excessive force is not applied to the LED. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the internal connection to fail causing a catastrophic failure (i.e. the LED not to illuminate).
- Dropping may cause damage to the LED (e.g. deformation).
- Do not stack assembled PCBs together. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the internal connection to fail causing a catastrophic failure (i.e. the LED not to illuminate).

(4) Design Consideration

- If the LEDs are soldered to a PCB and the PCB assembly is bent (e.g. PCB depaneling process), it may cause the LED package to break. The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB assembly is bent/warped.
- The amount of mechanical stress exerted on the LED from depaneling may vary depending on the LED position/orientation on the PCB assembly (e.g. especially in areas near V-groove scores). The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB is separated into individual PCB assemblies.
- To separate a PCB populated with the LEDs, use a specially designed tool. Do not break the PCB by hand.
- Volatile organic compounds that have been released from materials present around the LEDs (e.g. housing, gasket/seal, adhesive, secondary lens, lens cover, grease, etc.) may penetrate the LED emitting surface. If the LEDs are being used in a hermetically/near-hermetically sealed environment, these volatile compounds can discolor after being exposed to heat and/or photon energy and it may greatly reduce the LED light output and/or color shift. In this case, ventilating the environment may improve the reduction in light output and/or color shift. Perform a light-up test of the chosen application for optical evaluation prior to use to ensure that there are no issues, this test should be performed taking into consideration the conditions/environments in which the end-product containing these LEDs will actually be used.

(5) Electrostatic Discharge (ESD)

- This LED is sensitive to transient excessive voltages (e.g. ESD, lightning surge). If this excessive voltage occurs in the circuit, it
 may cause the LED to be damaged causing issues (e.g. the LED to become dimmer or not to illuminate [i.e. catastrophic failure]).
 Ensure that when handling the LEDs, necessary measures are taken to protect them from an ESD discharge. The following
 examples are recommended measures to eliminate the charge:
 - Grounded wrist strap, ESD footwear, clothes, and floors
 - Grounded workstation equipment and tools
 - ESD table/shelf mat made of conductive materials
- Ensure that all necessary measures are taken to prevent the LEDs from being exposed to transient excessive voltages (e.g. ESD, lightning surge):
 - tools, jigs, and machines that are used are properly grounded
 - appropriate ESD materials/equipment are used in the work area
 - the system/assembly is designed to provide ESD protection for the LEDs
- If the tool/equipment used is an insulator (e.g. glass cover, plastic, etc.), ensure that necessary measures have been taken to protect the LED from transient excessive voltages (e.g. ESD). The following examples are recommended measures to eliminate the charge:
 - Dissipating static charge with conductive materials
 - Preventing charge generation with moisture
 - Neutralizing the charge with ionizers
- To detect if an LED was damaged by transient excess voltages (i.e. an ESD event during the system's assembly process), perform a characteristics inspection (e.g. forward voltage measurement, light-up test) at low current (≤1mA).
- Failure Criteria: V_F <2.0V at I_F =0.5mA

If any one or more dice, except for the red die, are damaged by transient excess voltages (e.g. ESD), it will cause:

- the leakage current to increase
- the Forward Voltage (V_F) to decrease
- the LED not to illuminate at a low current

(6) Thermal Management

- The Absolute Maximum Junction Temperature (T_J) must not be exceeded under any circumstances. The increase in the temperature of an LED while in operation may vary depending on the PCB thermal resistance and the density of LEDs on the PCB assembly. Ensure that when using the LEDs for the chosen application, heat is not concentrated in an area and properly managed in the system/assembly.
- The operating current should be determined by considering the temperature conditions surrounding the LED (i.e. T_A). Ensure that when operating the LED, proper measures are taken to dissipate the heat.
- The following two equations can be used to calculate the LED junction temperature:

1) $T_J = T_A + R_{\theta JA} \cdot W$ 2) $T_J = T_S + R_{\theta JS} \cdot W$

*T_J=LED Junction Temperature: °C

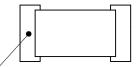
T_A=Ambient Temperature: °C

T_s=Soldering Temperature (Cathode Side): °C

 $R_{\theta JA}$ =Thermal Resistance from Junction to Ambient: °C/W

 $R_{\mbox{\tiny BJS}}\mbox{=}\mbox{Thermal}$ Resistance from Junction to T_S Measurement Point: °C/W

W=Input Power($I_F \times V_F$): W



T_s Measurement Point

(7) Cleaning

- When washing after soldering is needed, following conditions are requested.
 - a) Washing solvent: Pure Water
 - b) Temperature, time: 50°C or less×30seconds max. or 30°C or less×3 minutes max.
- Ultrasonic cleaning is not recommended since it may have adverse effects on the LEDs.

(8) Eye Safety

- There may be two important international specifications that should be noted for safe use of the LEDs: IEC 62471:2006 Photobiological safety of lamps and lamp systems and IEC 60825-1:2001 (i.e. Edition 1.2) Safety of Laser Products - Part 1: Equipment Classification and Requirements. Ensure that when using the LEDs, there are no issues with the following points:
 - LEDs have been removed from the scope of IEC 60825-1 since IEC 60825-1:2007 (i.e. Edition 2.0) was published. However, depending on the country/region, there are cases where the requirements of the IEC 60825-1:2001 specifications or equivalent must be adhered to.
 - LEDs have been included in the scope of IEC 62471:2006 since the release of the specification in 2006.
 - Most Nichia LEDs will be classified as the Exempt Group or Risk Group 1 according to IEC 62471:2006. However, in the case
 of high-power LEDs containing blue wavelengths in the emission spectrum, there are LEDs that will be classified as Risk
 Group 2 depending on the characteristics (e.g. radiation flux, emission spectrum, directivity, etc.)
 - If the LED is used in a manner that produces an increased output or with an optic to collimate the light from the LED, it may cause damage to the human eye.
- If an LED is operated in a manner that emits a flashing light, it may cause health issues (e.g. visual stimuli causing eye discomfort). The system should be designed to ensure that there are no harmful effects on the human body.

(9) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria as detailed in the Reliability section within this specification; it is the customer's responsibility to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required for the intended use are met.
- The applicable warranty period is one year from the date that the LED is delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia's discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- This LED is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices); it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, automobiles, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LED is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health. This LED does not comply with IATF 16949 and is not intended for automotive applications.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LED.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).